

# MBR350, MBR360

MBR360 is a Preferred Device

## Axial Lead Rectifiers

These devices employ the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

### Features

- Extremely Low  $v_F$
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Low Stored Charge, Majority Carrier Conduction
- Pb-Free Packages are Available\*

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode indicated by Polarity Band

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50 60	V
Average Rectified Forward Current $T_A = 65^\circ\text{C}$ ( $R_{\theta JA} = 28^\circ\text{C/W}$ , P.C. Board Mounting)	$I_O$	3.0	A
Non-Repetitive Peak Surge Current (Note 1) (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz, $T_L = 75^\circ\text{C}$ )	$I_{FSM}$	80	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient (see Note 4 - Mounting Data, Mounting Method 3)	$R_{\theta JA}$	28	$^\circ\text{C/W}$
--	-----------------	----	--------------------

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

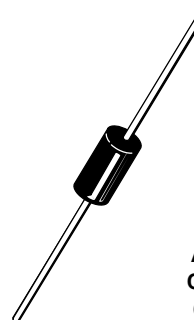
1. Lead Temperature reference is cathode lead 1/32 in from case.



ON Semiconductor®

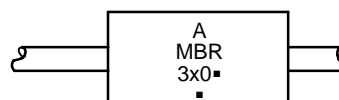
<http://onsemi.com>

**SCHOTTKY BARRIER  
RECTIFIERS  
3.0 AMPERES  
50, 60 VOLTS**



AXIAL LEAD  
CASE 267-05  
(DO-201AD)  
STYLE 1

### MARKING DIAGRAM



A = Assembly Location  
x = 5 or 6  
▪ = Pb-Free Package  
(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MBR350, MBR360

## ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ\text{C}$ unless otherwise noted) (Note 2)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 1.0$ Amp) ( $i_F = 3.0$ Amp) ( $i_F = 9.4$ Amp)	$V_F$	0.600 0.740 1.080	V
Maximum Instantaneous Reverse Current @ Rated DC Voltage (Note 3) $T_L = 25^\circ\text{C}$ $T_L = 100^\circ\text{C}$	$i_R$	0.60 20	mA

- Lead Temperature reference is cathode lead 1/32 in from case.
- Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%.

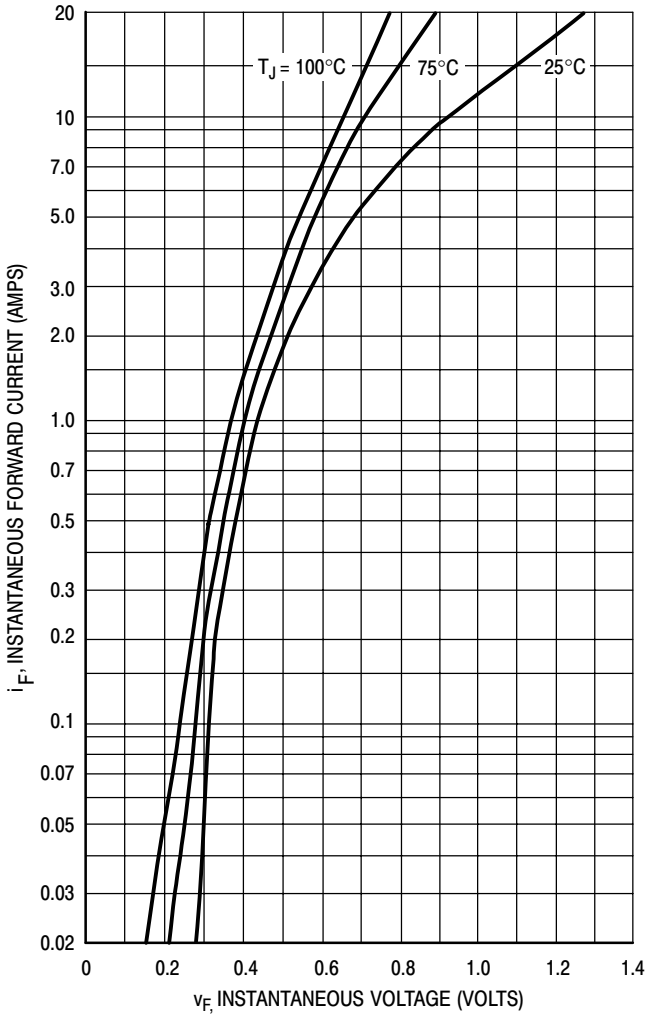


Figure 1. Typical Forward Voltage

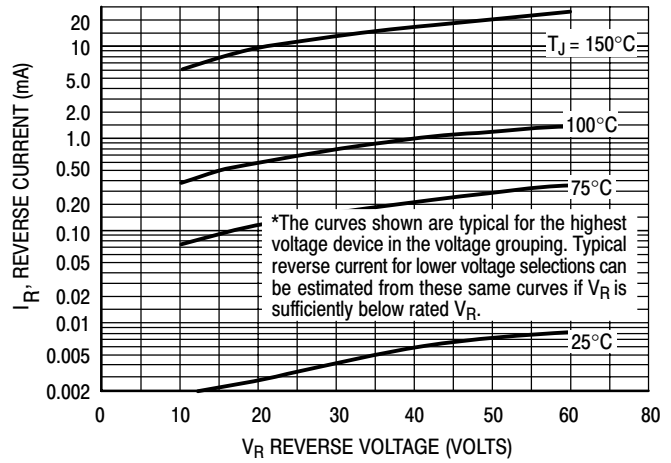


Figure 2. Typical Reverse Current\*

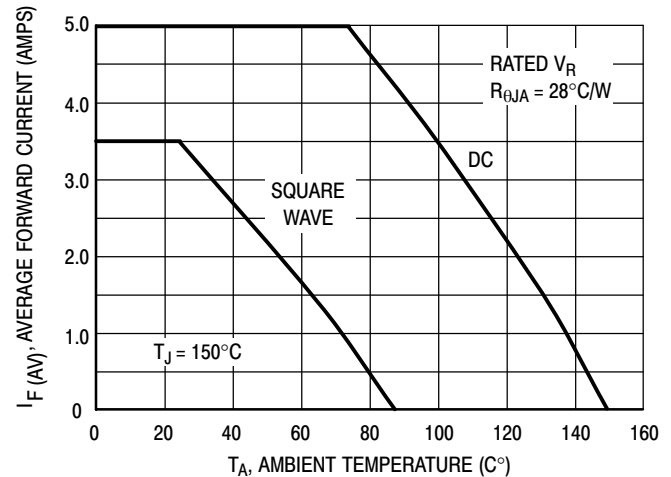


Figure 3. Current Derating Ambient  
(Mounting Method 3 per Note 4)

# MBR350, MBR360

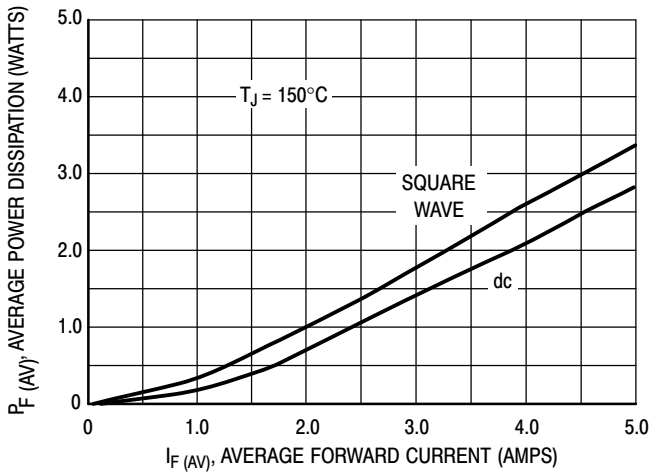


Figure 4. Power Dissipation

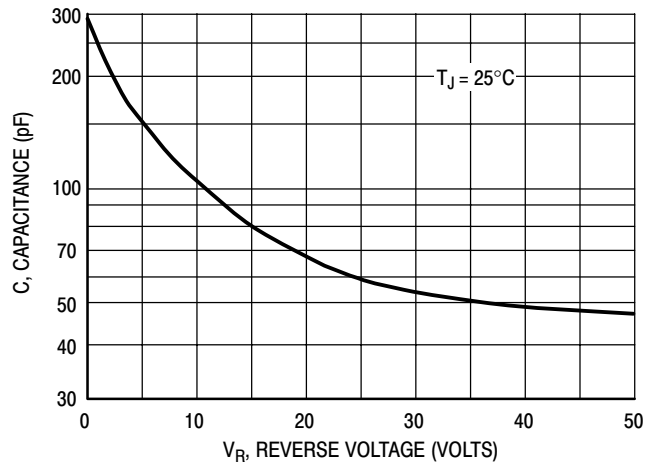


Figure 5. Typical Capacitance

## NOTE 4 — MOUNTING DATA

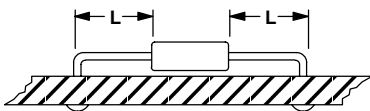
Data shown for thermal resistance, junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

### TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	50	51	53	55	$^{\circ}\text{C}/\text{W}$
2	58	59	61	63	$^{\circ}\text{C}/\text{W}$
3	28				$^{\circ}\text{C}/\text{W}$

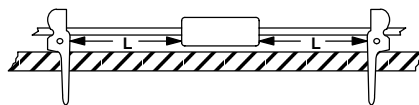
#### Mounting Method 1

P.C. Board where available copper surface is small.



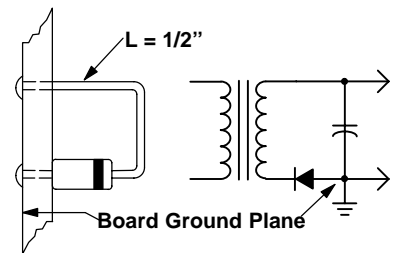
#### Mounting Method 2

Vector Push-In Terminals T-28



#### Mounting Method 3

P.C. Board with 2-1/2 in X 2-1/2 in copper surface.



## ORDERING INFORMATION

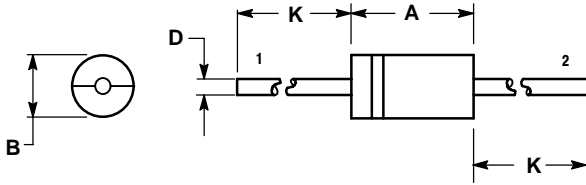
Device	Package	Shipping†
MBR350RL	Axial Lead	1500 Units / Tape & Reel
MBR350RLG	Axial Lead (Pb-Free)	1500 Units / Tape & Reel
MBR360	Axial Lead	500 Units / Bag
MBR360G	Axial Lead (Pb-Free)	500 Units / Bag
MBR360RL	Axial Lead	1500 Units / Tape & Reel
MBR360RLG	Axial Lead (Pb-Free)	1500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MBR350, MBR360

## PACKAGE DIMENSIONS


### AXIAL LEAD CASE 267-05 (DO-201AD) ISSUE G



- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.287	0.374	7.30	9.50
B	0.189	0.209	4.80	5.30
D	0.047	0.051	1.20	1.30
K	1.000	---	25.40	---

- STYLE 1:  
PIN 1. CATHODE (POLARITY BAND)  
2. ANODE

ON Semiconductor and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

**LITERATURE FULFILLMENT:**  
Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** orderlit@onsemi.com

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5773-3850

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local  
Sales Representative